

BGA Heat Sink - High Performance maxiFLOW/maxiGRIP-STD



*Image above is for illustration purpose only.

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|-------------------------|--|
| ATS Part#: | ATS-50350B-C1-R0 |
| Description: | 35.00 x 35.00 x 7.50 mm BGA Heat Sink - High Performance maxiFLOW/maxiGRIP-STD |
| Heat Sink Type: | maxiFLOW |
| Heat Sink Attachment: | maxiGRIP |
| Equivalent Part Number: | ATS-50350B-C2-R0 Discontinued |

Features & Benefits

- **maxiFLOW™** design features a low profile, spread fin array that maximizes surface area for more effective convection (air) cooling
- **maxiGRIP™** attachment applies steady, even pressure to the component and does not require holes in the PCB
- Meets Telcordia GR-63-Core Office Vibration; ETSI 300 019 Transportation Vibration; and MIL-STD-810 Shock and Unpackaged Drop Testing standards
- Comes preassembled with high performance, phase changing, thermal interface material
- Designed for standard height components from 3 to 4.5mm

Thermal Performance

| AIR VELOCITY | | @200 LFM 1.0 M/S | @300 LFM 1.5 M/S | @400 LFM 2.0 M/S | @500 LFM 2.5 M/S | @600 LFM 3.0 M/S | @700 LFM 3.5 M/S | @800 LFM 4.0 M/S |
|--------------------|---------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|---------------------|
| THERMAL RESISTANCE | Unducted Flow | 5.3 °C/W | 3.9 °C/W | 3.2 °C/W | 2.9 °C/W | 2.6 °C/W | 2.4 °C/W | 2.2 °C/W |
| | Ducted Flow | 3.4 | N/A | N/A | N/A | N/A | N/A | N/A |

Product Detail

| Schematic Image | Dimension A | Dimension B | Dimension C | Dimension D | TIM | Finish |
|--|-------------|-------------|-------------|-------------|------|---------------|
| <p>*Image above is for illustration purpose only.</p> | 35.00 mm | 35.00 mm | 7.50 mm | 44.9 mm | T766 | BLUE-ANODIZED |
| Notes: <ul style="list-style-type: none"> • Dimension A and B refer to component size. • Dimension C is the heat sink height from the bottom of the base to the top of the fin field. • ATS-50350B-C2-R0 is the exact heat sink assembly with an equivalent thermal interface material (Saint Gobain C1100F). NOTE: Saint Gobain C1100F is discontinued effective 12/31/10. • Thermal performance data are provided for reference only. Actual performance may vary by application. • ATS reserves the right to update or change its products without notice to improve the design or performance. • ATS certifies that this heat sink assembly is RoHS-6 and REACH compliant. • Optional maxiGRIP™ Installation/Removal Tool Set P/N: MGT350 • Contact ATS to learn about custom options available. | | | | | | |

For more information, to find a distributor or to place an order, please contact us at 781-769-2800 (North America), sales@qats.com or www.qats.com.

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